



Customer Information Notification

201805029I

Issue Date: 03-Jun-2018
Effective Date: 04-Jun-2018

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Change Category

- | | | | | |
|--|---|--|---|--|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input checked="" type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input checked="" type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

SC66746x Reference Manual, Datasheet, and Errata Update

Description

NXP Semiconductors announces Reference Manual, Data Sheet, and Errata update for SC66746x mask 2N58R. Each document provides a detailed description of the changes in the revision history.

Reference Manual update from Revision 3 to Revision 5.1:

- 1 - Revision 4 supersedes Revision 3
- 2 - Revision 5.1 supersedes Revision 4

Datasheet update from Revision 3.1 to Revision 5.2

- 1 - Revision 4 supersedes Revision 3.1
- 2 - Revision 5.2 supersedes Revision 4

Errata update from Revision 1 to Revision 2

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02

Reason

Reference Manual, Data Sheet, and Errata for SC66746x mask 2N58R have been updated to provide additional technical clarification on some device features.

Identification of Affected Products

Top side marking

Devices marked with date code WW16 2018 and later will be tested to the SSCM module changes outlined in Appendix A.67.2 in the Revision 5 Reference Manual.

Anticipated Impact on Form, Fit, Function, Reliability or Quality

Customer to assess potential hardware/software implications specific to device usage.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Existing inventory will be shipped until depleted

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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Affected Part Number

FS32R274KBK2MMM